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December 2013

FQP5N60C / FQPF5N60C

N-Channel QFET® MOSFET

600 V, 4.5 A, 2.5 Ω

Description

This N-Channel enhancement mode power MOSFET is • 4.5 A, 600 V, $R_{DS(on)}$ = 2.5 Ω (Max.) @ V_{GS} = 10 V, produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state

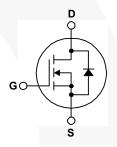
• Low Gate Charge (Typ. 15 nC) resistance, and to provide superior switching performance • Low Crss (Typ. 6.5 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- $I_D = 2.25 A$







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQP5N60C	FQPF5N60C	Unit
V_{DSS}	Drain-Source Voltage		6	00	V
I _D	Drain Current - Continuous (T _C = 25°C)		4.5	4.5 *	Α
	- Continuous (T _C = 100°C)		2.6	2.6 *	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	18	18 *	Α
V _{GSS}	Gate-Source Voltage	± 30		V	
E _{AS}	Single Pulsed Avalanche Energy (Not		210		mJ
I _{AR}	Avalanche Current	(Note 1)	4.5		Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		10		mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5		V/ns
P _D	Power Dissipation (T _C = 25°C)		100	33	W
	- Derate above 25°C	0.8	0.26	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300		°C	

^{*} Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FQP5N60C	FQPF5N60C	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	1.25	3.79	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink Typ, Max.	0.5		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQP5N60C	FQP5N60C	TO-220	Tube	N/A	N/A	50 units
FQPF5N60C	FQPF5N60C	TO-220F	Tube	N/A	N/A	50 units

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	600			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.6		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V			1	μΑ
		V _{DS} = 480 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V	-		-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 2.25 A		2.0	2.5	Ω
g _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 2.25 A		4.7		S
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		515 55 6.5	670 72 8.5	pF pF pF
Switchi	ing Characteristics					
t _{d(on)}	Turn-On Delay Time	V 000 V 1 4.5		10	30	ns
t _r	Turn-On Rise Time	$V_{DD} = 300 \text{ V}, I_{D} = 4.5$ A, R _G = 25 \Omega		42	90	ns
t _{d(off)}	Turn-Off Delay Time	A, NG - 25 32		38	85	ns
t _f	Turn-Off Fall Time	(Note 4)		46	100	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 4.5 A,		15	19	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	/	2.5		nC
Q _{gd}	Gate-Drain Charge	(Note 4)		6.6		nC
	ource Diode Characteristics a	nd Maximum Ratings				
I _S	Maximum Continuous Drain-Source Diode Forward Current				4.5	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				18	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 4.5 A)	1.4	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _S = 4.5 A,		300	//	ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs		2.2		μC

Notes: 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 18.9 mH, I_{AS} = 4.5 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C. 3.1 I_{SD} ≤ 4.5 A, di/dt ≤ 200 A/ μ s, V_{DD} ≤ BV $_{DSS}$, starting T_J = 25°C. 4. Essentially independent of operating temperature.

Typical Characteristics

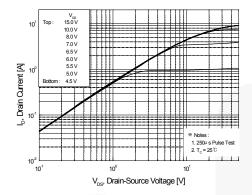
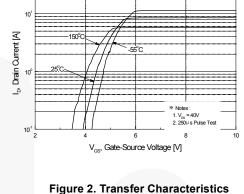


Figure 1. On-Region Characteristics



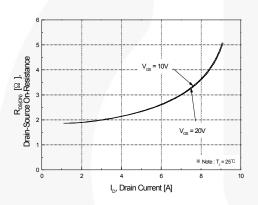


Figure 3. On-Resistance Variation vs **Drain Current and Gate Voltage**

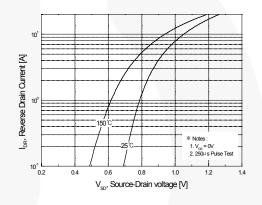


Figure 4. Body Diode Forward Voltage **Variation with Source Current** and Temperature

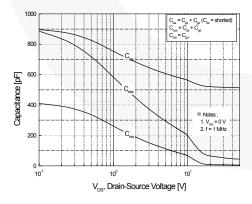


Figure 5. Capacitance Characteristics

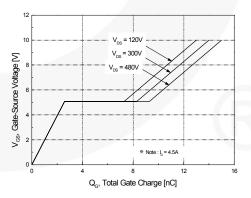


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

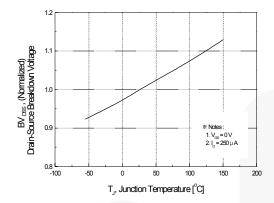


Figure 7. Breakdown Voltage Variation vs Temperature

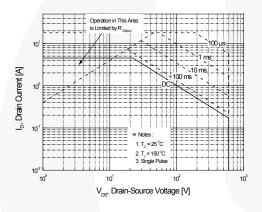


Figure 9-1. Maximum Safe Operating Area for FQP5N60C

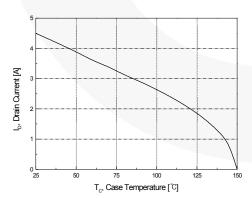


Figure 10. Maximum Drain Current vs Case Temperature

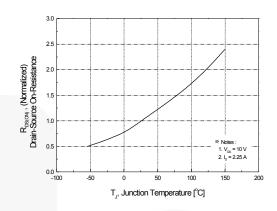


Figure 8. On-Resistance Variation vs Temperature

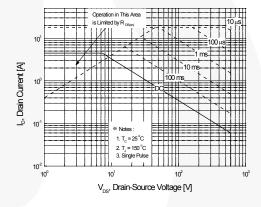


Figure 9-2. Maximum Safe Operating Area for FQPF5N60C

Typical Characteristics (Continued)

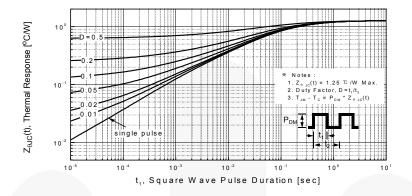


Figure 11-1. Transient Thermal Response Curve for FQP5N60C

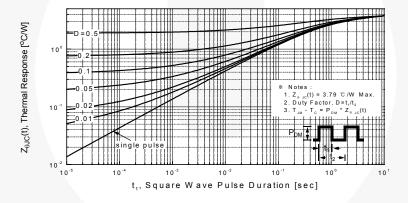


Figure 11-2. Transient Thermal Response Curve for FQPF5N60C

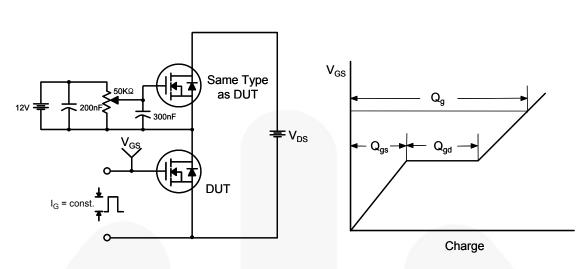


Figure 12. Gate Charge Test Circuit & Waveform

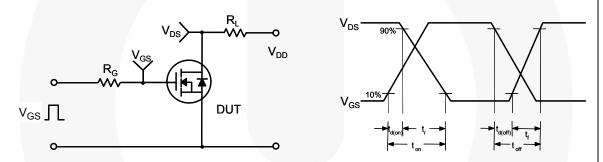


Figure 13. Resistive Switching Test Circuit & Waveforms

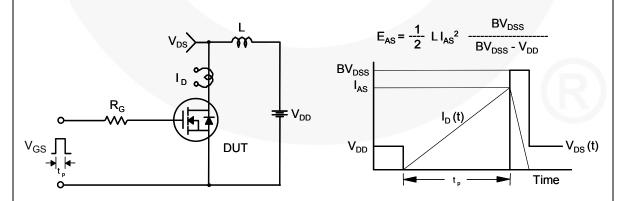
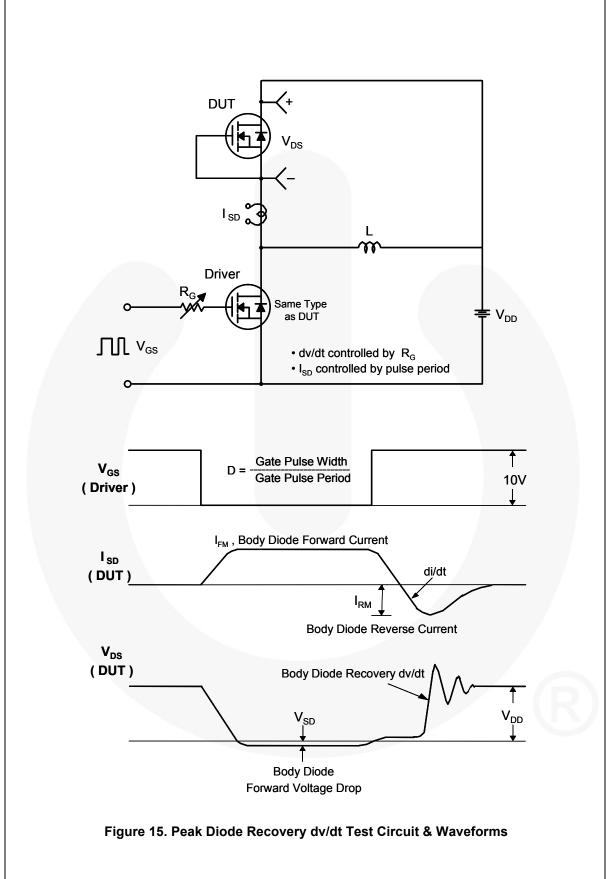


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions

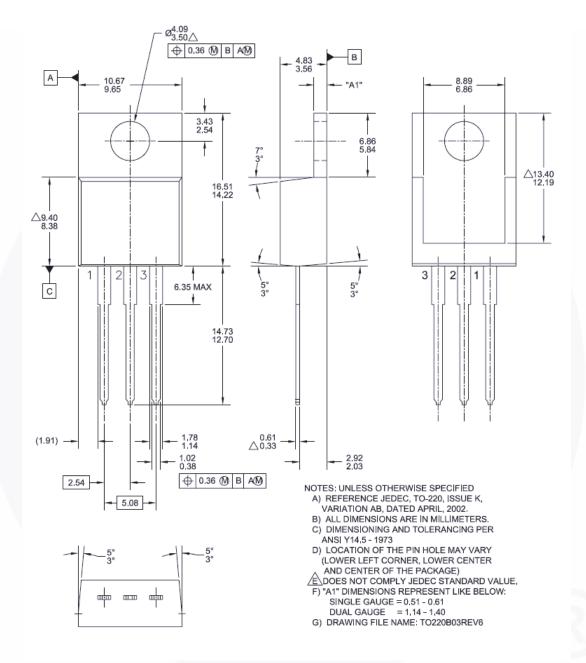


Figure 16. TO-220, Molded, 3-Lead, Jedec Variation AB

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Mechanical Dimensions

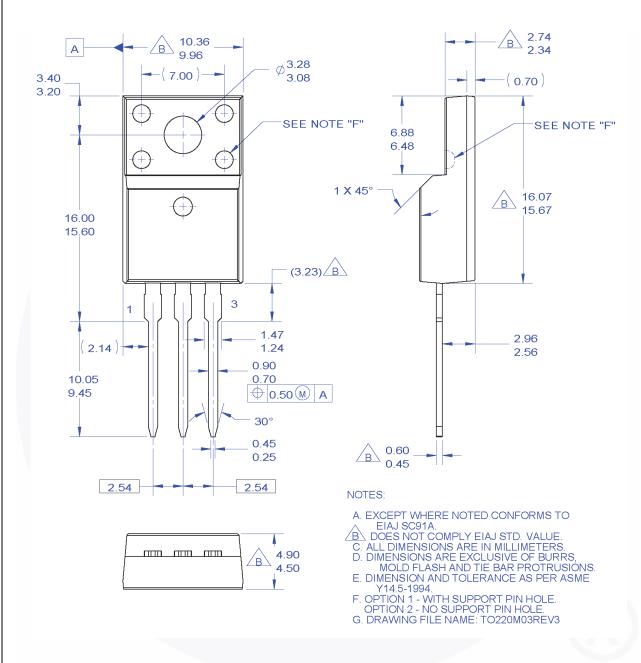


Figure 17. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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